

Docket No.: JCLA8534-D

Date: December 03, 2003

COMMISSIONER FOR PATENTS  
P.O. BOX 1450  
ALEXANDRIA, VA 22313-1450

ATTENTION: APPLICATION BRANCH

Sir:

This is a request for filing a continuation application under 37 CFR 1.53 (b) as a **divisional application** of prior application No. 10/055,499 filed on **January 22, 2002**.

Prior application information: **Examiner: THAI, LUAN C. ; Group Art Unit: 2827**

The entire disclosure of the prior application, from which an oath or declaration is supplied herewith as indicated below, is considered a part of the disclosure of the accompanying continuation or divisional application and is hereby incorporated by reference.

Transmitted herewith for filing is the patent application of

Inventor(s): JIN-YUAN LEE ;  
MOU-SHIUNG LIN ;  
CHING-CHENG HUANG ;

**For: INTEGRATED CHIP PACKAGE STRUCTURE USING ORGANIC SUBSTRATE AND METHOD OF MANUFACTURING THE SAME**

Enclosed are:

- (X) Specification in SIXTY-SIX ( 66 ) pages.
- (X) SEVENTEEN ( 17 ) sheets of Drawings.
- (X) Preliminary Amendment.
- (X) A copy of Declaration and Power of Attorney from the prior application is enclosed.
- (X) **Applicant claims small entity status. See 37 CFR 1.27.**
- (X) Return prepaid postcard.

CLAIMS AS FILED				
FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$ 385	\$ 385
Total Claims	88 - 20 =	68 ×	\$ 9	\$ 612
Independent Claims	3 - 3 =	0 ×	\$ 43	\$ 0
If application contains any multiple dependent claims(s), then add			\$ 145	\$ 0
<b>For a Small Entity:</b>	<b>TOTAL FILING FEE</b>			<b>\$ 997</b>

- (X) A check in the amount of \$ 997 to cover the filing fee is enclosed.
- (X) The commissioner is authorized to charge any additional necessary fee to Account No. 50-0710 (Order No. JCLA8534-D). A duplicate copy of this sheet is enclosed.

**Correspondence address:**  
J.C. Patents  
4 Venture, Suite 250  
Irvine, California 92618

  
Jiawei Huang  
Registration No. 43,330

22763 U.S. PTO  
120303

17510 U.S. PTO  
10/728150  
120303

Docket No.: JCLA8534-D

Date: December 03, 2003

**COMMISSIONER FOR PATENTS**  
**P.O. BOX 1450**  
**ALEXANDRIA, VA 22313-1450**

ATTENTION: APPLICATION BRANCH

Sir:

This is a request for filing a continuation application under 37 CFR 1.53 (b) **as a divisional application** of prior application No. **10/055,499** filed on **January 22, 2002**.

Prior application information: **Examiner:** THAI, LUAN C. ; **Group Art Unit:** 2827

The entire disclosure of the prior application, from which an oath or declaration is supplied herewith as indicated below, is considered a part of the disclosure of the accompanying continuation or divisional application and is hereby incorporated by reference.

Transmitted herewith for filing is the patent application of

Inventor(s): JIN-YUAN LEE ;

MOU-SHIUNG LIN ;

CHING-CHENG HUANG ;

**For: INTEGRATED CHIP PACKAGE STRUCTURE USING ORGANIC SUBSTRATE AND METHOD OF MANUFACTURING THE SAME**

Enclosed are:

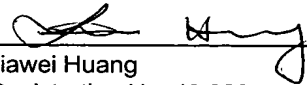
- (X) Specification in SIXTY-SIX ( 66 ) pages.
- (X) SEVENTEEN ( 17 ) sheets of Drawings.
- (X) Preliminary Amendment.
- (X) A copy of Declaration and Power of Attorney from the prior application is enclosed.
- (X) **Applicant claims small entity status. See 37 CFR 1.27.**
- (X) Return prepaid postcard.

#### CLAIMS AS FILED

FOR	NUMBER FILED	NUMBER EXTRA	RATE	FEE
Basic Fee			\$ 385	\$ 385
Total Claims	88 - 20 =	68 x	\$ 9	\$ 612
Independent Claims	3 - 3 =	0 x	\$ 43	\$ 0
If application contains any multiple dependent claims(s), then add			\$ 145	\$ 0
<b>For a Small Entity:</b>	<b>TOTAL FILING FEE</b>			<b>\$ 997</b>

- (X) A check in the amount of \$ 997 to cover the filing fee is enclosed.
- (X) The commissioner is authorized to charge any additional necessary fee to Account No. 50-0710 (Order No. JCLA8534-D). A duplicate copy of this sheet is enclosed.

**Correspondence address:**  
 J.C. Patents  
 4 Venture, Suite 250  
 Irvine, California 92618

  
 Jiawei Huang  
 Registration No. 43,330

**J.C. PATENTS**  
4 VENTURE, SUITE 250  
IRVINE, CALIFORNIA 92618  
TEL. (949) 660-0761  
FAX (949) 660-0809

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

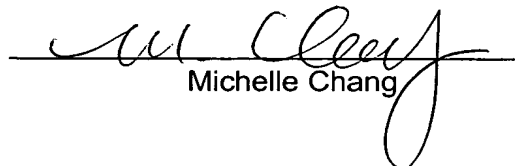
**CERTIFICATE OF MAILING BY "EXPRESS MAIL"**

**Docket No.** : JCLA8534-D  
**Inventor(s)** : JIN-YUAN LEE ;  
MOU-SHIUNG LIN ;  
CHING-CHENG HUANG ;  
  
**For** : INTEGRATED CHIP PACKAGE STRUCTURE USING  
ORGANIC SUBSTRATE AND METHOD OF MANUFACTURING  
THE SAME  
  
**"Express Mail"**  
**Mailing Label No.** : EV 300987635 US  
  
**Date of Deposit** : December 03, 2003

I hereby certify that the accompanying

Transmittal in Duplicate; Specification in 66 page(s); 17 sheets of  
drawing(s); Copy of Declaration and Power of Attorney from prior  
application; Preliminary Amendment; Checks for Filing Fee(s); Return  
Prepaid Postcard

are being deposited with the United States Postal Service "Express Mail Post Office to  
Addressee" service under 37 CFR 1.10 on the date indicated above and are  
addressed to the Commissioner for Patents, P.O. BOX 1450, Alexandria, VA 22313-  
1450

  
Michelle Chang